## MM54HC4051/MM74HC4051 8-Channel Analog Multiplexer MM54HC4052/MM74HC4052 Dual 4-Channel Analog Multiplexer MM54HC4053/MM74HC4053 Triple 2-Channel Analog Multiplexer

#### **General Description**

These multiplexers are digitally controlled analog switches implemented in advanced silicon-gate CMOS technology. These switches have low "on" resistance and low "off" leakages. They are bidirectional switches, thus any analog input may be used as an output and vice-versa. Also these switches contain linearization circuitry which lowers the on resistance and increases switch linearity. These devices allow control of up to  $\pm 6V$  (peak) analog signals with digital control signals of 0 to 6V. Three supply pins are provided for V<sub>CC</sub>, ground, and V<sub>FF</sub>. This enables the connection of 0-5V logic signals when  $V_{CC}$ =5V and an analog input range of  $\pm$ 5V when V<sub>EE</sub>=5V. All three devices also have an inhibit control which when high will disable all switches to their off state. All analog inputs and outputs and digital inputs are protected from electrostatic damage by diodes to V<sub>CC</sub> and around

MM54HC4051/MM74HC4051: This device connects together the outputs of 8 switches, thus achieving an 8 channel Multiplexer. The binary code placed on the A, B, and C select lines determines which one of the eight switches is "on", and connects one of the eight inputs to the common output.

MM54HC4052/MM74HC4052: This device connects together the outputs of 4 switches in two sets, thus achieving

a pair of 4-channel multiplexers. The binary code placed on the A, and B select lines determine which switch in each 4 channel section is "on", connecting one of the four inputs in each section to its common output. This enables the implementation of a 4-channel differential multiplexer.

MM54HC4053/MM74HC4053: This device contains 6 switches whose outputs are connected together in pairs, thus implementing a triple 2 channel multiplexer, or the equivalent of 3 single-pole-double throw configurations. Each of the A, B, or C select lines independently controls one pair of switches, selecting one of the two switches to be "on".

#### **Features**

- Wide analog input voltage range: ±6V
- Low "on" resistance: 50 typ. (V<sub>CC</sub>-V<sub>EE</sub> = 4.5V)

30 typ.  $(V_{CC}-V_{EE}=9V)$ 

- $\blacksquare$  Logic level translation to enable 5V logic with  $\pm 5\text{V}$  analog signals
- Low quiescent current: 80 µA maximum (74HC)
- Matched Switch characteristic

#### **Connection Diagrams Dual-In-Line Packages** IN/QUT IN/OUT OUT/IN IN/OUT OUT/IN 16 'HC4053 'HC4051 'HC4052 Y6 OUT/IN GŃD GND OUT/IN IN/OUT OUT/IN IN/OUT IN/ÔUT IN/OUT IN/OUT IN/OUT TL/F/5353-1 TL/F/5353-3 TL/F/5353-2 **Top View Top View Top View** Order Number MM54HC4051, MM74HC4051, MM54HC4052, MM74HC4052, MM54HC4053 or MM74HC4053

# Absolute Maximum Ratings (Notes 1 & 2) If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V<sub>CC</sub>) -0.5 to +7.5V Supply Voltage (V<sub>EE</sub>) +0.5 to -7.5V Control Input Voltage (VIN) -1.5 to  $V_{CC} + 1.5V$ Switch I/O Voltage (V<sub>IO</sub>)  $V_{\mbox{\footnotesize EE}}\!-\!0.5$  to  $V_{\mbox{\footnotesize CC}}\!+\!0.5V$ Clamp Diode Current (I<sub>IK</sub>, I<sub>OK</sub>)  $\pm\,20~mA$ Output Current, per pin (I<sub>OUT</sub>)  $\pm\,25~mA$ V<sub>CC</sub> or GND Current, per pin (I<sub>CC</sub>)  $\pm\,$ 50 mA Storage Temperature Range (T<sub>STG</sub>)  $-65^{\circ}\text{C}$  to  $+\,150^{\circ}\text{C}$ Power Dissipation (P<sub>D</sub>)

 (Note 3)
 600 mW

 S.O. Package only
 500 mW

 Lead Temp. (T<sub>L</sub>) (Soldering 10 seconds)
 260°C

## **Operating Conditions**

	Min	Max	Units
Supply Voltage (V <sub>CC</sub> )	2	6	V
Supply Voltage (V <sub>EE</sub> )	0	-6	V
DC Input or Output Voltage (V <sub>IN</sub> , V <sub>OUT</sub> )	0	$V_{CC}$	V
Operating Temp. Range (TA)			
MM74HC	-40	+85	°C
MM54HC	-55	+125	°C
Input Rise or Fall Times			
$(t_r, t_f)$	$V_{CC} = 2.0V$	1000	ns
	$V_{CC} = 4.5V$	500	ns
	$V_{CC} = 6.0V$	400	ns

#### **DC Electrical Characteristics** (Note 4)

Symbol	Parameter		Conditions	V <sub>EE</sub>	v <sub>cc</sub>		= 25°C	74HC T <sub>A</sub> = -40 to 85°C Guaranteed	54HC T <sub>A</sub> = -55 to 125°C	Units
V <sub>IH</sub>	Minimum High Level Input Voltage				2.0V 4.5V 6.0V	Тур	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V V
V <sub>IL</sub>	Maximum Low Level Input Voltage**	I			2.0V 4.5V 6.0V		0.5 1.35 1.8	0.5 1.35 1.8	0.5 1.35 1.8	V V
R <sub>ON</sub>	R <sub>ON</sub> Maximum "ON" Resistance (Note 5)		$V_{INH} = V_{IL}$ , $I_S = 2.0$ mA $V_{IS} = V_{CC}$ to $V_{EE}$ (Figure 1) $V_{INH} = V_{IL}$ , $I_S = 2.0$ mA	-4.5V -6.0V	4.5V 6.0V	30 20	160 120 100 230	200 150 125 280	240 170 140 320	$\Omega$ $\Omega$ $\Omega$
			V <sub>IS</sub> =V <sub>CC</sub> or V <sub>EE</sub> (Figure 1)	GND -4.5V -6.0V	4.5V	40 20 15	110 90 80	140 120 100	170 140 115	$\Omega$
R <sub>ON</sub>	Maximum "ON"Resistance Matching		$V_{CTL} = V_{IL}$ $V_{IS} = V_{CC}$ to GND	GND -4.5V -6.0V	4.5V	5	20 10 10	25 15 12	25 15 15	$\Omega$ $\Omega$
I <sub>IN</sub>	Maximum Control Input Current		$V_{IN} = V_{CC}$ or GND $V_{CC} = 2-6V$				±0.1	± 1.0	±1.0	μΑ
Icc	Maximum Quiescent Supply Current	t	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$	GND -6.0V	6.0V 6.0V		8 16	80 160	160 320	μA μA
I <sub>IZ</sub>	Maximum Switch "OFF" Leakage Current (Switch Input)		$V_{OS} = V_{CC}$ or $V_{EE}$ $V_{IS} = V_{EE}$ or $V_{CC}$ $V_{INH} = V_{IH}$ (Figure 2)	GND -6.0V			±60 ±100	±600 ±1000	±600 ±1000	nA nA
I <sub>IZ</sub>	Maximum Switch "ON" Leakage Current	HC4051	$V_{IS} = V_{CC}$ to $V_{EE}$ $V_{INH} = V_{IL}$ (Figure 3)	GND -6.0V			±0.2 ±0.4		±2.0 ±4.0	μA μA
		HC4052	$V_{IS} = V_{CC}$ to $V_{EE}$ $V_{INH} = V_{IL}$ (Figure 3)	GND -6.0V			±0.1 ±0.2	±1.0 ±2.0	±1.0 ±2.0	μA μA
		HC4053	$V_{IS} = V_{CC}$ to $V_{EE}$ $V_{INH} = V_{IL}$ (Figure 3)	GND -6.0V			±0.1 ±0.1	± 1.0 ± 1.0	± 1.0 ± 1.0	μA μA

#### DC Electrical Characteristics (Note 4) (Continued)

Symbol	Parameter		Conditions	Conditions V <sub>EE</sub> V <sub>C</sub>		T <sub>A</sub> =	= 25°C	74HC T <sub>A</sub> = -40 to 85°C	54HC T <sub>A</sub> = -55 to 125°C	Units
						Тур		Guaranteed		
I <sub>IZ</sub>	Maximum Switch		V <sub>OS</sub> =V <sub>CC</sub> or V <sub>EE</sub>	GND	6.0V		±0.2	±2.0	±2.0	μΑ
	"OFF" Leakage	HC4051	V <sub>IS</sub> =V <sub>EE</sub> or V <sub>CC</sub>	-6.0V	6.0V		±0.4	±4.0	± 4.0	μΑ
	Current (Common		$V_{INH} = V_{IH}$							
	Pin)		V <sub>OS</sub> =V <sub>CC</sub> or V <sub>EE</sub>	GND	6.0V		±0.1	± 1.0	±1.0	μΑ
		HC4052	V <sub>IS</sub> =V <sub>EE</sub> or V <sub>CC</sub>	-6.0V	6.0V		±0.2	±2.0	±2.0	μΑ
			$V_{INH} = V_{IH}$							
			V <sub>OS</sub> =V <sub>CC</sub> or V <sub>EE</sub>		6.0V		±0.1	±1.0	±1.0	μΑ
			V <sub>IS</sub> =V <sub>EE</sub> or V <sub>CC</sub>	-6.0V	6.0V		±0.1	±1.0	±1.0	μΑ
			$V_{INH} = V_{IH}$							

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

Note 4: For a power supply of 5V  $\pm$ 10% the worst case on resistances (R<sub>ON</sub>) occurs for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub>=5.5V and 4.5V respectively. (The V<sub>IH</sub> value at 5.5V is 3.85V.) The worst case leakage current occur for CMOS at the higher voltage and so the 5.5V values should be used.

Note 5: At supply voltages (V<sub>CC</sub>–V<sub>EE</sub>) approaching 2V the analog switch on resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital only when using these supply voltages.

Note 6: Adjust 0 dB for f = 1 kHz (Null R1/R $_{\mbox{ON}}$  Attenuation).

### $\textbf{AC Electrical Characteristics} \ v_{\text{CC}} = 2.0 \text{V} - 6.0 \text{V}, \ v_{\text{EE}} = 0 \text{V} - 6 \text{V}, \ C_{\text{L}} = 50 \ \text{pF (unless otherwise specified)}$

Symbol	Parameter	Conc	litions	V <sub>EE</sub>	v <sub>cc</sub>	T <sub>A</sub> =:	25°C	74HC T <sub>A</sub> = -40 to 85°C	54HC T <sub>A</sub> = -55 to 125°C	Units
						Тур		Guarantee	d Limits	
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation			GND	2.0V	25	60	75	90	ns
	Delay Switch In to			GND	4.5V	5	12	15	18	ns
	Out			-4.5V	4.5V	4	8	12	14	ns
				-6.0V	6.0V	3	7	11	13	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Maximum Switch Turn	$R_L = 1 k\Omega$		GND	2.0V	92	355	435	515	ns
	"ON" Delay	-		GND	4.5V		69	87	103	ns
	-			-4.5V	4.5V	16	46	58	69	ns
				-6.0V	6.0V	15	41	51	62	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Maximum Switch Turn			GND	2.0V	65	290	365	435	ns
	"OFF" Delay			GND	4.5V	28	58	73	87	ns
	•	•		-4.5V	4.5V	18	37	46	56	ns
				-6.0V	6.0V	16	32	41	48	ns
f <sub>MAX</sub>	Minimum Switch Frequency Response 20 log (V <sub>I</sub> /V <sub>O</sub> )=3 dB			GND -4.5V	4.5V 4.5V	30 35				MHz MHz
	Control to Switch Feedthrough Noise		$V_{IS} = 4 V_{PP}$ $V_{IS} = 8 V_{PP}$		4.5V 4.5V	l .				mV mV
	Crosstalk between any Two Switches	_	V <sub>IS</sub> =4 V <sub>PP</sub> V <sub>IS</sub> =8 V <sub>PP</sub>	0V -4.5V	4.5 4.5V	-52 -50				dB dB
	Switch OFF Signal Feedthrough Isolation	_	V <sub>IS</sub> =4 V <sub>PP</sub> V <sub>IS</sub> =8 V <sub>PP</sub>	0V -4.5V	4.5V 4.5V					dB dB
THD	Sinewave Harmonic Distortion		$V_{IS} = 4 V_{PP}$ $V_{IS} = 8 V_{PP}$			0.013 0.008				% %

<sup>\*\*</sup>  $V_{IL}$  limits are currently tested at 20% of  $V_{CC}$ . The above  $V_{IL}$  specification (30% of  $V_{CC}$ ) will be implemented no later than Q1, CY'89.

#### **AC Electrical Characteristics**

 $V_{CC}$ =2.0V-6.0V,  $V_{EE}$ =0V-6V,  $C_L$ =50 pF (unless otherwise specified) (Continued)

Symbol	Parameter	Conditions	VEE	v <sub>cc</sub>	T <sub>A</sub> =	25°C	74HC T <sub>A</sub> = -40 to 85°C	54HC T <sub>A</sub> = -55 to 125°C	Units				
					Тур		Guaranteed	l Limits					
C <sub>IN</sub>	Maximum Control Input Capacitance				5	10	10	10	pF				
C <sub>IN</sub>	Maximum Switch Input Capacitance	Input 4051 Common 4052 Common 4053 Common			15 90 45 30				pF				
C <sub>IN</sub>	Maximum Feedthrough Capacitance				5				pF				

#### **Truth Tables**

'4051

	Inp	ut		"ON"
Inh	С	В	Α	Channel
Н	Х	Χ	Χ	None
L	L	L	L	Y0
L	L	L	Н	Y1
L	L	Н	L	Y2
L	L	Н	Н	Y3
L	Н	L	L	Y4
L	Н	L	Н	Y5
L	Н	Н	L	Y6
L	Н	Н	Н	Y7

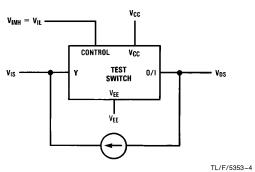
'∆	n	52	•

Inputs			"ON" Channels				
Inh	В	Α	х	Υ			
Н	Х	Χ	None	None			
L	L	L	0X	0Y			
L	L	Н	1X	1Y			
L	Н	L	2X	2Y			
L	Н	Н	3X	3Y			

'4053

	Inp	ut		"ON	nels	
Inh	С	В	Α	С	b	а
Н	х	Χ	Χ	None	None	None
L	L	L	L	CX	BX	AX
L	L	L	Н	CX	BX	AY
L	L	Н	L	CX	BY	AX
L	L	Н	Н	CX	BY	AY
L	Н	L	L	CY	BX	AX
L	Н	L	Н	CY	BX	AY
L	Н	Н	L	CY	BY	AX
L	Н	Н	Н	CY	BY	AY

## **AC Test Circuits and Switching Time Waveforms**



 $v_{IS} = v_{EE} \text{ OR } v_{CC} \xrightarrow{\text{AMMETER}} v_{IS} = v_{CC} \text{ OR } v_{EE}$   $v_{IS} = v_{EE} \text{ OR } v_{CC} \xrightarrow{\text{AMMETER}} v_{CE}$   $v_{IS} = v_{EE} \text{ OR } v_{CC} \text{ OR } v_{EE}$   $v_{EE} \text{ OR } v_{CC} \text{ OR } v_{EE}$   $v_{EE} \text{ OR } v_{CC} \text{ OR } v_{EE}$ 

FIGURE 2. "OFF" Channel Leakage Current

FIGURE 1. "ON" Resistance

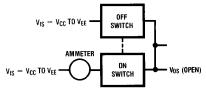


FIGURE 3. "ON" Channel Leakage Current

TL/F/5353-6

## AC Test Circuits and Switching Time Waveforms (Continued)

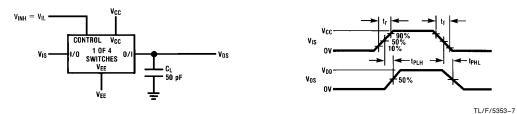


FIGURE 4.  $t_{\text{PHL}}$ ,  $t_{\text{PLH}}$  Propagation Delay Time Signal Input to Signal Output

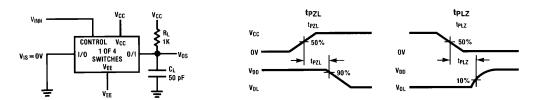


FIGURE 5.  $t_{\mbox{\scriptsize PZL}}, t_{\mbox{\scriptsize PLZ}}$  Propagation Delay Time Control to Signal Output

TL/F/5353-8

TL/F/5353-9

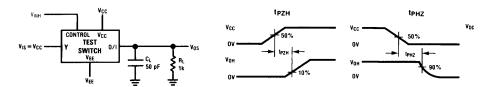


FIGURE 6. t<sub>PZH</sub>, t<sub>PHZ</sub> Propagation Delay TIme Control to Signal Output

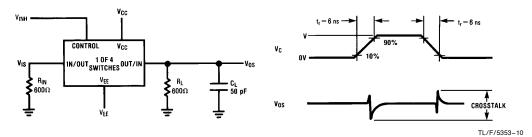
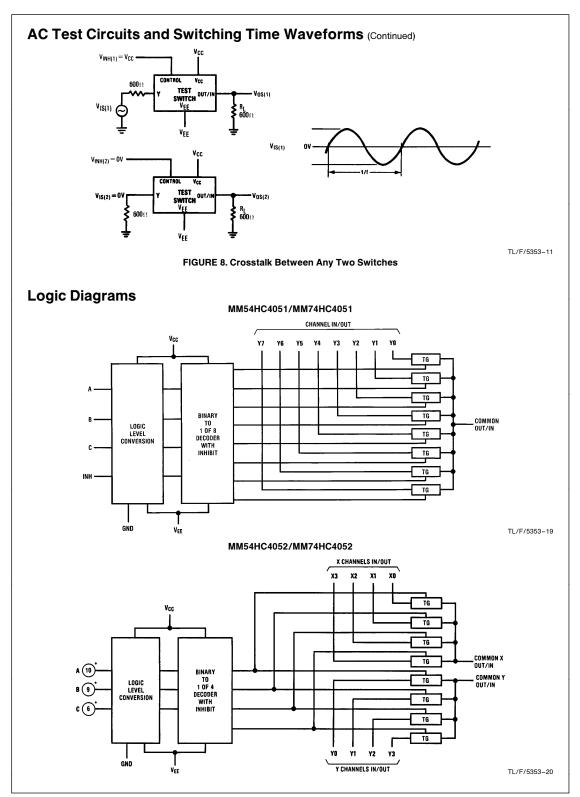
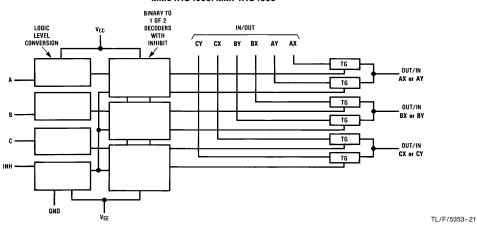


FIGURE 7. Crosstalk: Control Input to Signal Output

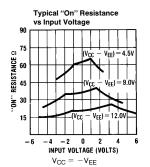


## Logic Diagrams (Continued)

#### MM54HC4053/MM74HC4053



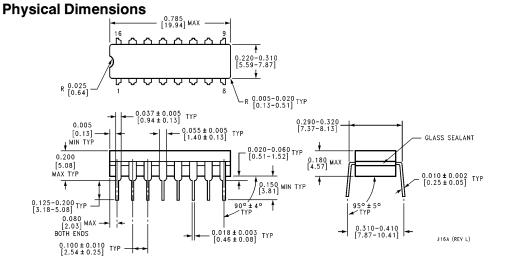
## **Typical Performance Characteristics**



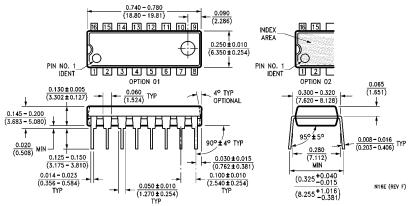
TL/F/5353-18

## **Special Considerations**

In certain applications the external load-resistor current may include both  $V_{CC}$  and signal line components. To avoid drawing  $V_{CC}$  current when switch current flows into the analog switch pins, the voltage drop across the switch must not exceed 1.2V (calculated from the ON resistance).



Order Number MM54HC4051J, MM54HC4052J, MM54HC4053J, MM74HC4051J, MM74HC4052J, or MM74HC4053J NS Package J16A



Order Number MM74HC4051N, MM74HC4052N, or MM74HC4053N NS Package N16E

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